1A

1Y 👖

1Z 🛛 3

G 🛛 4

2Z [5

2Y 🛛 6

 $2A\Pi 7$

GND 8

3Z

G

NC

2Z

2Y

8

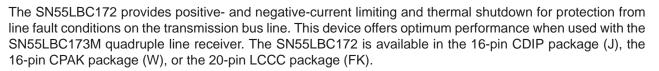
2

Meets Standard EIA-485

- Designed for High-Speed Multipoint Transmission on Long Bus Lines in Noisy Environments
- Supports Data Rates up to and Exceeding Ten Million Transfers Per Second
- Common-Mode Output Voltage Range of -7 V to 12 V
- Positive- and Negative-Current Limiting
- Low Power Consumption . . . 1.5 mA Max (Output Disabled)

description

The SN55LBC172 is a monolithic quadruple differential line driver with 3-state outputs. This device is designed to meet the requirements of the Electronics Industry Association (EIA) standard RS-485. The SN55LBC172 is optimized for balanced multipoint bus transmission at data rates up to and exceeding 10 million bits per second. The driver features wide positive and negative common-mode output voltage ranges, current limiting, and thermal-shutdown circuitry, making it suitable for party-line applications in noisy environments. The device is designed using the LinBiCMOS[™] process, facilitating ultralow power consumption and inherent robustness.



The SN55LBC172 is characterized for operation over a military temperature range of -55°C to 125°C.

FUNCTION TABLE (each driver)								
ENA	BLES	OUTPUTS						
G	G	Y	Z					
Н	Х	Н	L					
Н	Х	L	Н					
Х	L	н	L					
Х	L	L	Н					
L	Н	Z	Z					
	(e ENAI G H H X	(each drivENABLESGGHXHXXLXLXL	(each driver)ENABLESOUTIGGYHXHHXLXLHXLXL					

H = high level, L = low level, X = irrelevant, Z = high impedance (off)



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1

SGLS084A - MARCH 1995 - REVISED NOVEMBER 1998

J OR W PACKAGE (TOP VIEW)

FK PACKAGE

(TOP VIEW)

2

10

GND

NC - No internal connection

16 VCC

15 🛛 4A

14 **1** 4Y

13 🛛 4Z

12 1 G

11 🛛 3Z

10 3Y

9 🛛 3A

^ 0 4

12 13

š

20 19

4Y

17 **(**4Z

16 (NC

15 (G

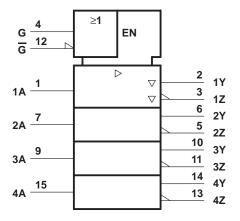
3Z

18

14

SGLS084A - MARCH 1995 - REVISED NOVEMBER 1998

logic symbol[†]

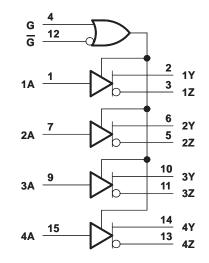


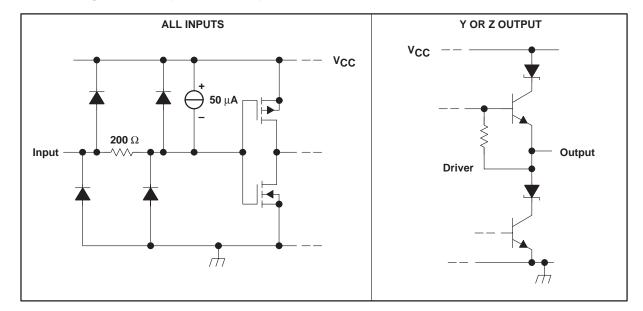
⁺ This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

Pin numbers shown are for the J or W package.

schematic diagrams of inputs and outputs

logic diagram (positive logic)







SGLS084A - MARCH 1995 - REVISED NOVEMBER 1998

absolute maximum ratings over operating free-air temperature (unless otherwise noted)[†]

Supply voltage range, V _{CC} (see Note 1)	
Output voltage range, VO	–10 V to 15 V
Input voltage range, V ₁	–0.3 V to 7 V
Continuous power dissipation	Internally limited [‡]
Operating free-air temperature range, T _A	–55°C to 125°C
Storage temperature range, T _{stg}	–65°C to 150°C
Lead temperature 1,6 mm (1/16 inch) from case for 10 seconds	–65°C to 150°C

[†] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

[‡] The maximum operating junction temperature is internally limited. Use the dissipation rating table to operate below this temperature. NOTE 1: All voltage values are with respect to GND.

PACKAGE	$\begin{array}{llllllllllllllllllllllllllllllllllll$		T _A = 125°C POWER RATING						
FK	1375 mW	11.0 mW/°C	275 mW						
J	1375 mW	11.0 mW/°C	275 mW						
W	1000 mW	8.0 mW/°C	200 mW						

DISSIPATION RATING TABLE

recommended operating conditions

			MIN	NOM	MAX	UNIT
Supply voltage, V _{CC}			4.75	5	5.25	V
High-level input voltage, VIH			2			V
Low-level input voltage, V _{IL}					0.8	V
Output voltage at any bus terminal (separately or common mode), V_{O}	mode), V _O Y or Z				12	V
Output voltage at any bus terminal (separately of common mode), v()				-7	v	
High-level output current, IOH	Y or Z				-60	mA
Low-level output current, IOL	Y or Z				60	mA
Continuous total power dissipation			See D	Dissipatio	n Rating	g Table
Operating free-air temperature, T _A			-55		125	°C



SGLS084A - MARCH 1995 - REVISED NOVEMBER 1998

electrical characteristics over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

PARAMETER		TEST CONDITIONS		MIN	түр†	MAX	UNIT			
VIK	Input clamp voltage	lj = -18 mA				-1.5	V			
IV and		RL = 54 Ω,	See Figure 1	1.1	1.8	5	V			
IVODI	Differential output voltage [‡]	RL = 60 Ω,	See Figure 2	1.1	1.7	5	v			
$\Delta V_{OD} $	Change in magnitude of differential output voltage§					±0.2	V			
Voc	Common-mode output voltage	R _L = 54 Ω,	See Figure 1			3 - 1	V			
	Change in magnitude of common-mode output voltage§	1	1						±0.2	V
IO	Output current with power off	$V_{CC} = 0,$	$V_{O} = -7$ V to 12 V			±100	μΑ			
I _{OZ}	High-impedance-state output current	$V_{O} = -7 V$ to 12 V				±100	μΑ			
Iн	High-level input current	V ₁ = 2.4 V				-100	μΑ			
۱ _{IL}	Low-level input current	V _I = 0.4 V				-100	μΑ			
IOS	Short-circuit output current	$V_{O} = -7 V$ to 12 V				±250	mA			
	Supply surrent (all drivers)	No load	Outputs enabled			7	mA			
ICC	Supply current (all drivers)	No load	Outputs disabled			1.5	ША			

[†] All typical values are at $V_{CC} = 5 \text{ V}$ and $T_A = 25^{\circ}\text{C}$.

[‡] The minimum V_{OD} specification does not fully comply with EIA-485 at operating temperatures below 0°C. The lower output signal should be used to determine the maximum signal transmission distance.

 $\Delta |V_{OD}|$ and $\Delta |V_{OC}|$ are the changes in magnitude of V_{OD} and V_{OC} , respectively, that occur when the input is changed from a high level to a low level.

switching characteristics, $V_{CC} = 5 V$

	PARAMETER	TEST CONDITIONS		TA	MIN	TYP	MAX	UNIT			
tuan	Differential output delay time $R_{I} = 54 \Omega$,		See Figure 3	25°C	2	11	20	ns			
^t d(OD)			-55°C to 125°C	2		40	115				
tuon	Differential output transition time $R_1 = 54 \Omega$, S	See Figure 3	25°C	10	15	25					
^t t(OD)		ις = 04 32,	See Figure 5	-55° C to 125° C	4		60	ns			
t==	Output enable time to high level	$P_{1} = 110.0$	See Figure 4	25°C			30	ns			
^t PZH	Output enable time to high level	R _L = 110 Ω,	KL = 110 32, 500 F	See Figure 4	-55° C to 125° C			40	115		
t	Output enable time to low level	D. 110.0	D: 110.0	R _I = 110 Ω,	$P_{1} = 110.0$	2, See Figure 5	25°C			30	20
^t PZL	Output enable time to low level	$K_{L} = 110.32$,	See Figure 5	-55° C to 125°C				ns			
t	Output disable time from high level	D 440.0	D. 110.0	R _I = 110 Ω,	See Figure 4	25°C			60	ns	
^t PHZ	Output disable time from high level	$K_{L} = 110.32$,	_ = 110 sz, See Figure 4	-55°C to 125°C			115	115			
	Output disable time from low level	R _I = 110 Ω,	See Figure 5	25°C			30	ns			
^t PLZ		110 32,	occ rigule o	-55°C to 125°C			55	115			



SGLS084A - MARCH 1995 - REVISED NOVEMBER 1998

PARAMETER MEASUREMENT INFORMATION

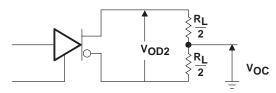


Figure 1. Differential and Common-Mode Output Voltages

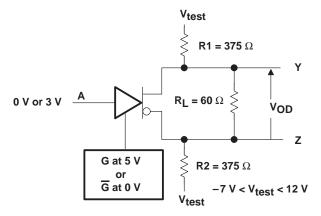
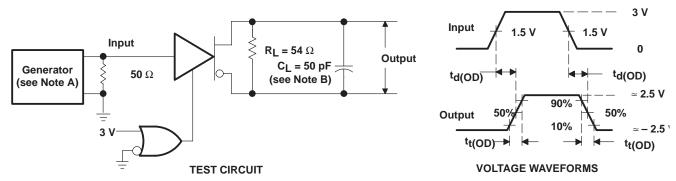


Figure 2. Driver V_{OD} Test Circuit



NOTES: A. The input pulses are supplied by a generator having the following characteristics: PRR \leq 1 MHz, duty cycle \leq 50%, t_f \leq 5 ns, t_f \leq 5 ns, Z_O = 50 Ω .

B. $\ C_L$ includes probe and stray capacitance.





SGLS084A - MARCH 1995 - REVISED NOVEMBER 1998

PARAMETER MEASUREMENT INFORMATION 3 V Input **S**1 1.5 V 1.5 V Output 0 V or 3 V 0 Input 0.5 V $R_L = 110 \Omega$ ^tPZH Generator C_L = 50 pF ★. ξ VOH (see Note A) **50** Ω (see Note B) ₽ Output 2.3 V $V_{off} \approx 0$ **t**PHZ **TEST CIRCUIT**

- NOTES: A. The input pulse is supplied by a generator having the following characteristics: PRR \leq 1 MHz, duty cycle \leq 50%, t_f \leq 5 ns, t_f \leq 5 ns, Z_O = 50 Ω .
 - B. C_L includes probe and stray capacitance.

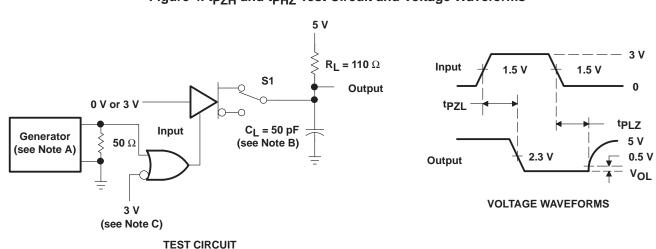


Figure 4. tPZH and tPHZ Test Circuit and Voltage Waveforms

VOLTAGE WAVEFORMS

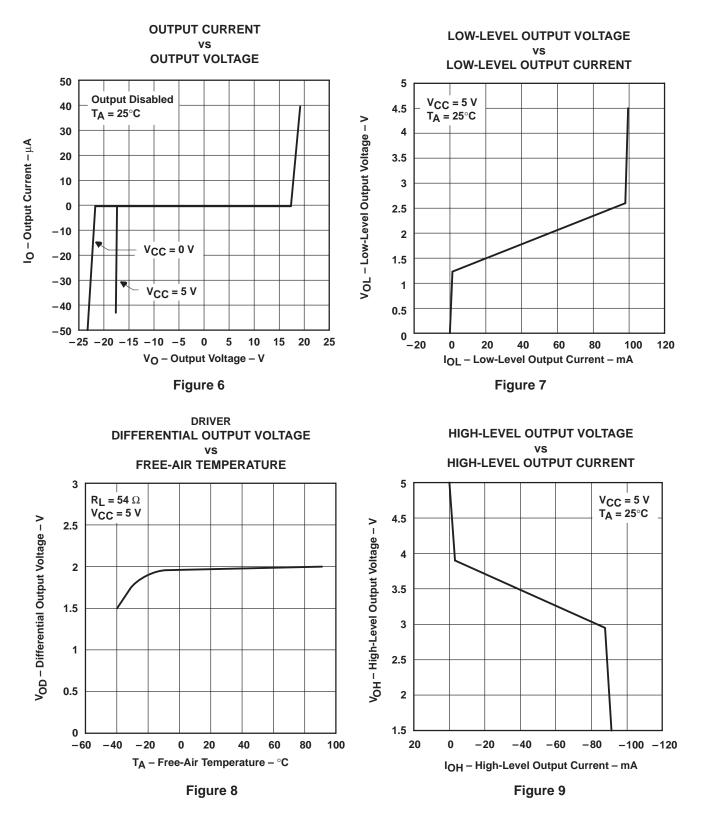
- NOTES: A. The input pulse is supplied by a generator having the following characteristics: PRR \leq 1 MHz, duty cycle \leq 50%, t_r \leq 5 ns, t_f \leq 5 ns, Z_O = 50 Ω .
 - B. $\ C_L$ includes probe and stray capacitance.
 - C. To test the active-low enable \overline{G} , ground G and apply an inverted waveform to \overline{G} .

Figure 5. tPZL and tPLZ Test Circuit and Waveforms



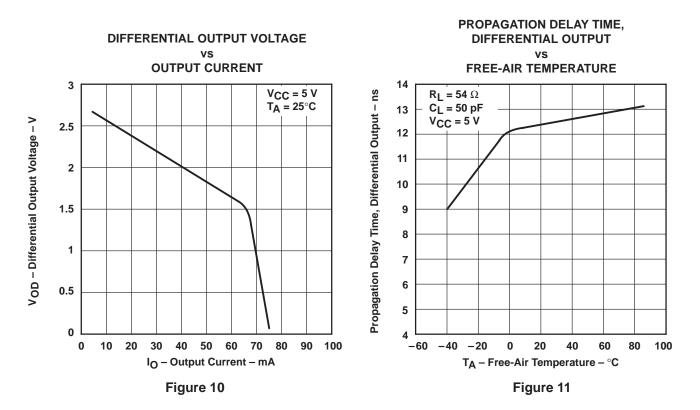
SGLS084A - MARCH 1995 - REVISED NOVEMBER 1998

TYPICAL CHARACTERISTICS





SGLS084A - MARCH 1995 - REVISED NOVEMBER 1998



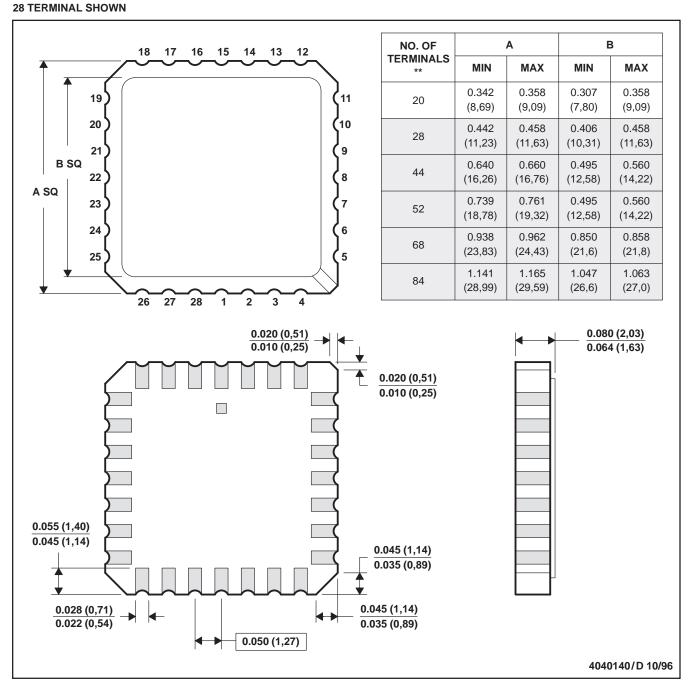
TYPICAL CHARACTERISTICS



SGLS084A - MARCH 1995 - REVISED NOVEMBER 1998

LEADLESS CERAMIC CHIP CARRIER

FK (S-CQCC-N**)



NOTES: A. All linear dimensions are in inches (millimeters).

- B. This drawing is subject to change without notice.
- C. This package can be hermetically sealed with a metal lid.
- D. The terminals are gold plated.
- E. Falls within JEDEC MS-004

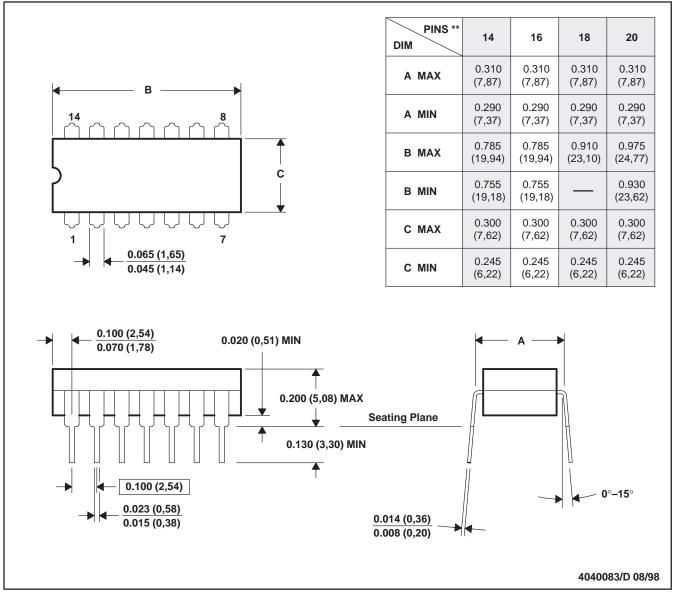


SGLS084A - MARCH 1995 - REVISED NOVEMBER 1998

MECHANICAL DATA

CERAMIC DUAL-IN-LINE PACKAGE

J (R-GDIP-T**) 14 PIN SHOWN



NOTES: A. All linear dimensions are in inches (millimeters).

- B. This drawing is subject to change without notice.
- C. This package can be hermetically sealed with a ceramic lid using glass frit.
- D. Index point is provided on cap for terminal identification only on press ceramic glass frit seal only.
- E. Falls within MIL STD 1835 GDIP1-T14, GDIP1-T16, GDIP1-T18, GDIP1-T20, and GDIP1-T22.

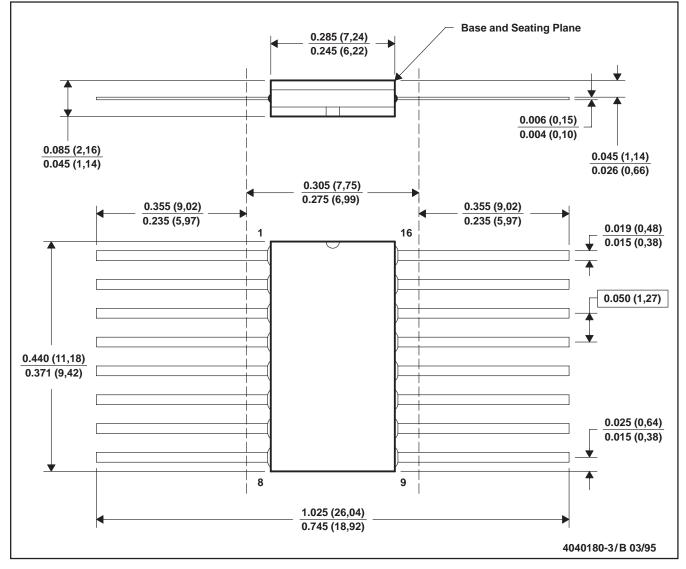


SGLS084A - MARCH 1995 - REVISED NOVEMBER 1998

MECHANICAL DATA

CERAMIC DUAL FLATPACK

W (R-GDFP-F16)



NOTES: A. All linear dimensions are in inches (millimeters).

- B. This drawing is subject to change without notice.
- C. This package can be hermetically sealed with a ceramic lid using glass frit.
- D. Index point is provided on cap for terminal identification only.
- E. Falls within MIL-STD-1835 GDFP1-F16 and JEDEC MO-092AC



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